

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L25	2	"4519401".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/03 11:56
L26	53	("3853117"   "4080653"   "4281667"   "4407296").PN. OR ("4519401").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/03 11:57
S2	2	"20070273392"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:06
S3	2	"20070273392"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:07
S4	893	(intracorporeal or intracorporal or dura or craini\$2) same pressure	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:14
S5	619	(intraepaenychymal or intraventricular) same pressure	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:18
S6	689	(S4 OR S5) and (sensor or transducer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:19
S8	6	("4660568"   "5951487"   "6083174").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:25
S9	77	("3034356"   "3038465"   "3625199"   "3680387"   "3720108"   "3722373"   "3724274"   "3724275"   "3727463"   "3757770"   "3853117"   "3859489"   "3943915"   "4014319"   "4022190"   "4026276"   "4027661"   "4067241"   "4124023"   "4127110"   "4499394"   "4519401"   "4685469"   "4722348"   "4738267"   "4815471"   "4825786"   "5207103"   "5263244"   "5715827"   "5951487").PN. OR ("4660568"   "5951487"   "6083174").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/02 11:26
S10	208	implant and semi adj (rigid or stiff) same (circuit or foil or rod)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 11:40
S12	12	foil same circuit same implant	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 12:32

S13	25	("20020045921"   "2786899"   "3672352"   "3970987"   "4041954"   "4099530"   "4651740"   "4793825"   "5113859"   "5749909"   "5833603"   "5861018"   "6140740"   "6164284"   "6185452"   "6200265"   "6236889"   "6248080").PN. OR ("6764446").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/02 12:34
S14	883	(600/561).OCL.S	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 12:39
S15	1327	(600/485).OCL.S	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 12:39
S16	642	(600/486).OCL.S	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 12:39
S17	366	(600/488).OCL.S	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 12:40
S18	2353	polyimide same (circuit or foil) same (stiff\$ or camber\$3 or rigid\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:25
S19	42	polyimide same (circuit or foil) same (stiff\$ or camber\$3 or rigid\$3) and implant	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:26
S21	609	semi adj rigid same electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:39
S22	55	semi adj rigid same electrode and implant	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:40
S23	2120	flex adj (PCB or (circuit adj board))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:50
S24	133	S23 and (implant or needle)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:50
S25	13731	bend\$3 same circuit same board	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:53

S26	168	bend\$3 same circuit same (board or substrate) and implant	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:53
S28	37	bend\$3 same shank\$2 and brain	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 13:57
S29	195	(324/654).CCL.S.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 14:13
S30	311	(600/373).CCL.S.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 14:16
S31	3	("4133735"   "4461304"   "4969468").PN. OR ("6834200").URFN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/01/02 14:19
S32	434	(600/372).CCL.S.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 14:29
S33	171	(600/377).CCL.S.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 14:39
S34	140	(600/378).CCL.S.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 14:40
S35	871	CP same (sensor or transducer)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 15:58
S36	568	(73/727).CCL.S.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 16:45
S37	0	("circuitsamechipsameframe").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/01/02 16:46
S39	10990	circuit same chip with frame	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 16:47
S41	2147	(circuit same sensor same frame) and (pressure same sensor)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 16:48

S42	73	(circuit same sensor same frame) and (pressure same sensor) and implant	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 16:48
S51	652	(PCB or circuit board) same (hole or open \$3) with chip and pressure same sensor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 17:01
S52	163	PCB with chip with (recess or depression)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 17:06
S53	23	"4341903"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/01/02 17:14

1/3/2008 1:57:27 PM

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